

# Automotive N-Channel 40 V (D-S) 175 °C MOSFET

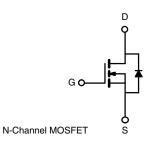
| PRODUCT SUMMARY                          |        |  |  |  |  |
|--|--------|--|--|--|--|
| V <sub>DS</sub> (V)                      | 40     |  |  |  |  |
| $R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$ | 0.0027 |  |  |  |  |
| I <sub>D</sub> (A)                       | 100    |  |  |  |  |
| Configuration                            | Single |  |  |  |  |
| Package                                  | TO-263 |  |  |  |  |



### FEATURES

- TrenchFET<sup>®</sup> power MOSFET
- Package with low thermal resistance
- 100 %  $R_{\rm q}$  and UIS tested
- AEC-Q101 qualified <sup>d</sup>
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>





| <b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise noted) |                                     |                 |      |    |  |
|--|-------------------------------------|-----------------|------|----|--|
| PARAMETER  | SYMBOL                              | LIMIT           | UNIT |    |  |
| Drain-Source Voltage   | V <sub>DS</sub>                     | 40              | V    |    |  |
| Gate-Source Voltage  | V <sub>GS</sub>                     | ± 20            | v    |    |  |
| Continuous Drain Current   | T <sub>C</sub> = 25 °C <sup>a</sup> | 1               | 100  |    |  |
| Continuous Drain Current   | T <sub>C</sub> = 125 °C             | I <sub>D</sub>  | 98   |    |  |
| Continuous Source Current (Diode Conduction) <sup>a</sup>                        | I <sub>S</sub>                      | 100             | А    |    |  |
| Pulsed Drain Current <sup>b</sup>  | I <sub>DM</sub>                     | 400             |      |    |  |
| Single Pulse Avalanche Current   | L = 0.1 mH                          | I <sub>AS</sub> | 70   |    |  |
| Single Pulse Avalanche Energy  | L = 0.1 mm                          | E <sub>AS</sub> | 245  | mJ |  |
| Maximum Power Dissipation <sup>b</sup>   | T <sub>C</sub> = 25 °C              | PD              | 157  | w  |  |
|  | T <sub>C</sub> = 125 °C             | ۲D              | 52   | VV |  |
| Operating Junction and Storage Temperature Rar                                   | T <sub>J</sub> , T <sub>stg</sub>   | -55 to +175     | ۵°   |    |  |

| THERMAL RESISTANCE RATINGS |                        |                   |       |      |  |
|----------------------------|------------------------|-------------------|-------|------|--|
| PARAMETER                  |                        | SYMBOL            | LIMIT | UNIT |  |
| Junction-to-Ambient        | PCB Mount <sup>c</sup> | R <sub>thJA</sub> | 40    | °C/W |  |
| Junction-to-Case (Drain)   |                        | R <sub>thJC</sub> | 0.95  | C/W  |  |

#### Notes

- a. Package limited.
- b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.
- c. When mounted on 1" square PCB (FR4 material).
- d. Parametric verification ongoing.

# SQM100N04-2m7



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| PARAMETER                                     | SYMBOL                     | TES  | T CONDITIONS  | MIN. | TYP.    | MAX.    | UNIT |
|---|----------------------------|--|---|------|---------|---------|------|
| Static  |                            | •  |   |      |         |         |      |
| Drain-Source Breakdown Voltage                | V <sub>DS</sub>            | $V_{GS} = 0, I_D = 250 \ \mu A$  |   | 40   | -       | -       | v    |
| Gate-Source Threshold Voltage                 | V <sub>GS(th)</sub>        | V <sub>DS</sub> =  | = V <sub>GS</sub> , I <sub>D</sub> = 250 μA                   | 2.5  | 3.0     | 3.5     | v    |
| Gate-Source Leakage                           | I <sub>GSS</sub>           | $V_{DS} = 0 V, V_{GS} = \pm 20 V$  |   | -    | -       | ± 100   | nA   |
|   |                            | $V_{GS} = 0 V$   | V <sub>DS</sub> = 40 V  | -    | -       | 1       |      |
| Zero Gate Voltage Drain Current               | I <sub>DSS</sub>           | $V_{GS} = 0 V$   | $V_{DS} = 40 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$ | -    | -       | 50      | μA   |
|   |                            | $V_{GS} = 0 V$   | $V_{DS} = 40 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$ | -    | -       | 250     |      |
| On-State Drain Current <sup>a</sup>           | I <sub>D(on)</sub>         | V <sub>GS</sub> = 10 V   | $V_{DS} \ge 5 V$  | 120  | -       | -       | Α    |
|   |                            | $V_{GS} = 10 V$  | I <sub>D</sub> = 30 A   | -    | 0.00225 | 0.00270 |      |
| Drain-Source On-State Resistance <sup>a</sup> | R <sub>DS(on)</sub>        | $V_{GS} = 10 V$  | I <sub>D</sub> = 30 A, T <sub>J</sub> = 125 °C                | -    | -       | 0.00440 | Ω    |
|   |                            | V <sub>GS</sub> = 10 V   | I <sub>D</sub> = 30 A, T <sub>J</sub> = 175 °C                | -    | -       | 0.00540 |      |
| Forward Transconductance <sup>b</sup>         | g <sub>fs</sub>            | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A  |   | -    | 201     | -       | S    |
| Dynamic <sup>b</sup>                          |                            |  |   |      |         |         |      |
| Input Capacitance                             | C <sub>iss</sub>           |  |   | -    | 6325    | 7910    |      |
| Output Capacitance                            | C <sub>oss</sub>           | $V_{GS} = 0 V$   | V <sub>DS</sub> = 25 V, f = 1 MHz                             | -    | 744     | 930     | pF   |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>           |  |   | -    | 314     | 395     |      |
| Total Gate Charge <sup>c</sup>                | Qg                         |  |   | -    | 95.5    | 145     |      |
| Gate-Source Charge <sup>c</sup>               | Q <sub>gs</sub>            | $V_{GS} = 10 V$  | $V_{DS} = 20 \text{ V}, I_{D} = 100 \text{ A}$                | -    | 25.5    | -       | nC   |
| Gate-Drain Charge <sup>c</sup>                | Q <sub>gd</sub>            |  |   | -    | 14.7    | -       |      |
| Gate Resistance                               | Rg                         | f = 1 MHz  |   | 0.7  | 1.48    | 3.8     | Ω    |
| Turn-On Delay Time <sup>c</sup>               | t <sub>d(on)</sub>         |  |   |      | 14      | 21      |      |
| Rise Time <sup>c</sup>                        | t <sub>r</sub>             | $V_{DD} = 20 \text{ V}, \text{ R}_{L} = 0.2 \Omega$ $\text{I}_{D} \cong 100 \text{ A}, \text{ V}_{GEN} = 10 \text{ V}, \text{ R}_{g} = 1 \Omega$ |   | -    | 11      | 17      | ns   |
| Turn-Off Delay Time <sup>c</sup>              | t <sub>d(off)</sub>        |  |   | -    | 48      | 72      |      |
| Fall Time <sup>c</sup>                        | t <sub>f</sub>             |  |   | -    | 9       | 14      |      |
| Source-Drain Diode Ratings and Cha            | aracteristics <sup>b</sup> |  |   |      |         |         |      |
| Pulsed Current <sup>a</sup>                   | I <sub>SM</sub>            |  |   | -    | -       | 400     | Α    |
| Forward Voltage                               | V <sub>SD</sub>            | I <sub>F</sub> = 30 A, V <sub>GS</sub> = 0   |   |      | 0.8     | 1.5     | V    |

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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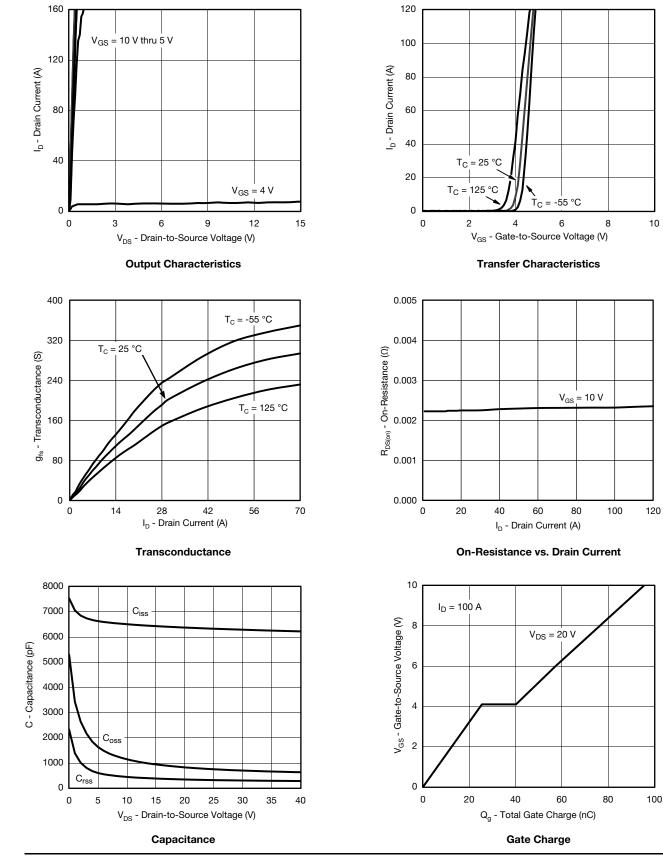
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SQM100N04-2m7

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## **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



S15-1874-Rev. B, 10-Aug-15

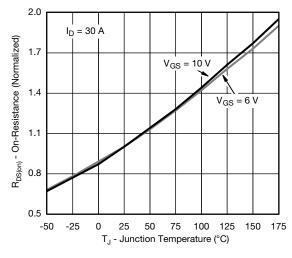
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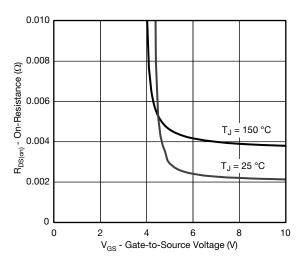
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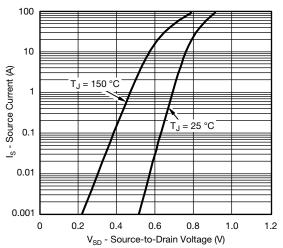
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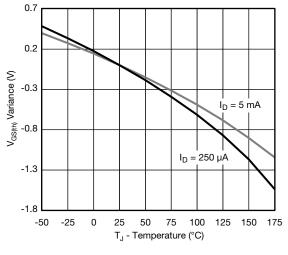
**On-Resistance vs. Junction Temperature** 



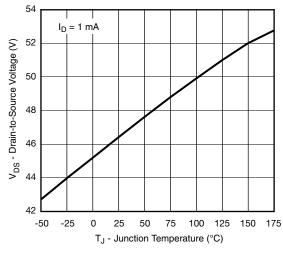
On-Resistance vs. Gate-to-Source Voltage



Source Drain Diode Forward Voltage







Drain Source Breakdown vs. Junction Temperature 4

S15-1874-Rev. B, 10-Aug-15

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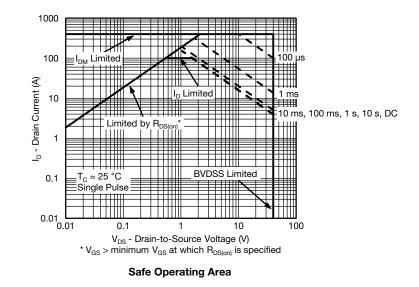
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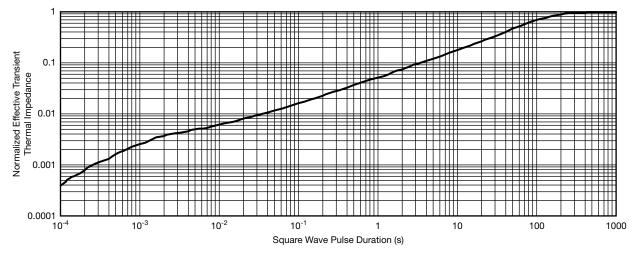


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### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



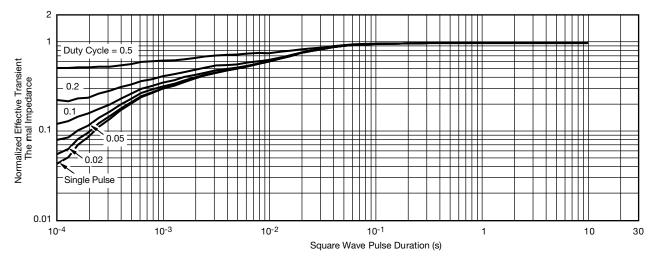


Normalized Thermal Transient Impedance, Junction-to-Ambient



Document Number: 62769

### THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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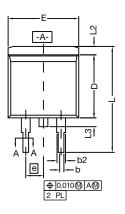
| REVISION HISTORY <sup>a</sup> |           |                                      |  |  |
|-------------------------------|-----------|--------------------------------------|--|--|
| REVISION                      | DATE      | DESCRIPTION OF CHANGE                |  |  |
| В                             | 04-Aug-15 | Revised R <sub>g</sub> minimum limit |  |  |

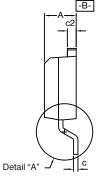
Note

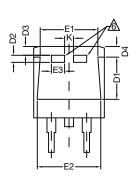
a. As of April 2014



TO-263 (D<sup>2</sup>PAK): 3-LEAD









DETAIL A (ROTATED 90°)



|  |            | INC       | HES   | MILLIMETERS |        |  |
|--|------------|-----------|-------|-------------|--------|--|
| DIM.   |            | MIN.      | MAX.  | MIN.        | MAX.   |  |
| A  |            | 0.160     | 0.190 | 4.064       | 4.826  |  |
|  | b          | 0.020     | 0.039 | 0.508       | 0.990  |  |
|  | b1         | 0.020     | 0.035 | 0.508       | 0.889  |  |
|  | b2         | 0.045     | 0.055 | 1.143       | 1.397  |  |
| с*   | Thin lead  | 0.013     | 0.018 | 0.330       | 0.457  |  |
| С  | Thick lead | 0.023     | 0.028 | 0.584       | 0.711  |  |
| <u></u>                                      | Thin lead  | 0.013     | 0.017 | 0.330       | 0.431  |  |
| c1   | Thick lead | 0.023     | 0.027 | 0.584       | 0.685  |  |
|  | c2         | 0.045     | 0.055 | 1.143       | 1.397  |  |
|  | D          | 0.340     | 0.380 | 8.636       | 9.652  |  |
|  | D1         | 0.220     | 0.240 | 5.588       | 6.096  |  |
|  | D2         | 0.038     | 0.042 | 0.965       | 1.067  |  |
|  | D3         | 0.045     | 0.055 | 1.143       | 1.397  |  |
|  | D4         | 0.044     | 0.052 | 1.118       | 1.321  |  |
|  | E          | 0.380     | 0.410 | 9.652       | 10.414 |  |
| E1   |            | 0.245     | -     | 6.223       | -      |  |
| E2   |            | 0.355     | 0.375 | 9.017       | 9.525  |  |
| E3   |            | 0.072     | 0.078 | 1.829       | 1.981  |  |
| е  |            | 0.100 BSC |       | 2.54 BSC    |        |  |
| К  |            | 0.045     | 0.055 | 1.143       | 1.397  |  |
| L  |            | 0.575     | 0.625 | 14.605      | 15.875 |  |
| L1   |            | 0.090     | 0.110 | 2.286       | 2.794  |  |
| L2   |            | 0.040     | 0.055 | 1.016       | 1.397  |  |
| L3   |            | 0.050     | 0.070 | 1.270       | 1.778  |  |
| L4   |            | 0.010 BSC |       | 0.254 BSC   |        |  |
| М  |            | -         | 0.002 | -           | 0.050  |  |
| ECN: T13-0707-Rev. K, 30-Sep-13<br>DWG: 5843 |            |           |       |             |        |  |

#### Notes

- 1. Plane B includes maximum features of heat sink tab and plastic. 2. No more than 25  $\,\%\,$  of L1 can fall above seating plane by
- max. 8 mils.3. Pin-to-pin coplanarity max. 4 mils.
- 4. \*: Thin lead is for SUB, SYB.
  - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

This feature is for thick lead.

Revison: 30-Sep-13



## **RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

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